

Docket No. <u>01-234</u>

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Commissioner of Patents and Trademarks Washington, D.C. 20231

Re:

Inventors: Colin D. Yates, Nicholas F. Pasch, and Nicholas K. Eib

Title.

ALIGNMENT PROCESS FOR INTEGRATED CIRCUIT STRUCTURES ON SEMICONDUCTOR SUBSTRATE USING SCATTEROMETRY MEASUREMENTS OF LATENT IMAGES IN SPACED

APART TEST FIELDS ON SUBSTRATE

Transmitted	herewith	is	the	patent	application	identified	above,	including:
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- Specification, claims and abstract, totaling 13 pages.
- Drawings totaling 3 pages, ___ Formal X Informal.
- Signed Declaration and Power of Attorney.
- Request and Certification Under 35 U.S.C. 122(b)(2)(B)(i).

Information Disclosure Statement and 4 accompanying disclosures.



FEE CALCULATION						
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total	
Total Claims	19	-20=	0	x \$18.00	\$0.00	
Independent Claims	3	-3=	0	x \$84.00	\$0.00	
Multiple Dependent Claim Fee (for one or more) \$280.00 \$0.0						
Basic Filing Fee \$740.00 \$740.00						
TOTAL FEES \$740.0						

	Attached	is	a	check	in	the	amount	of	\$	
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- The Commissioner is hereby authorized to charge \$ 740.00 to Deposit Account No. _X_ 12-2252
- The Commissioner is hereby authorized to charge any additional fees which may be _X_ required, or credit any overpayment to Deposit Account No. 12-2252 . A duplicate copy of this transmittal is enclosed.
- XXPlease address all future correspondence to:

Sandeep Jaggi, Chief IP Counsel Intellectual Property Law Department LSI Logic Corporation 1551 McCarthy Boulevard M/S D-106 Milpitas, CA 95035

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Assistant Commissioner for Patents, U.S. Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

Express Mail Receipt No. <u>ET662218698US</u>

Date of Deposit November 30, 2001

PATENT TRADEMARK OFFICE

Respectfully submitted,

John P. Taylor Patent Attorney

oh F. Jaylor

Registration No. 22,369

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Approved for use through 10/31/2002, OMB 0651-0031
U.S. Patent and Trademark Office; U. S. DEPARTMENT OF COMMERCE

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REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

i .		Colin Yates et al.
Title	ALIGNMENT P STRUCTURES	ROCESS FOR INTEGRATED CIRCUIT ON SEMICONDUCTOR SUBSTRATE
Atty [Docket Number	01-234

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

November 30, 2001
Date

Signature

John P. Taylor

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).